

S606 Thermal Compound

Feature特性

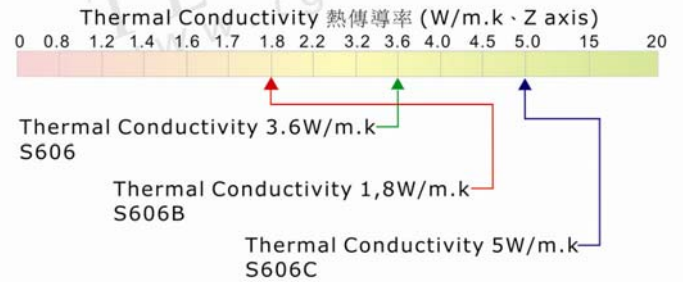
- Good thermal conductivity 良好的導熱性
- Easy to assemble 容易施工
- High stability 高穩定性
- Would not harden 不乾硬化

Application產品應用端

- Electronic components: IC、CPU、MOS、LED、M/B、P/S、Heat Sink.
- LCD-TV、Notebook PC、PC、Telecom Device、Wireless Hub..... etc.
- DDR II Module、DVD Applications、Hand-set applications.....etc.

GLOBAL TECHNOLOGY
Thermal Compound
S606 Heat Sink Paste
Color: White
Weight: 30g
Thermal Conductivity: 3.6W/m.k

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TECHNOLOGY

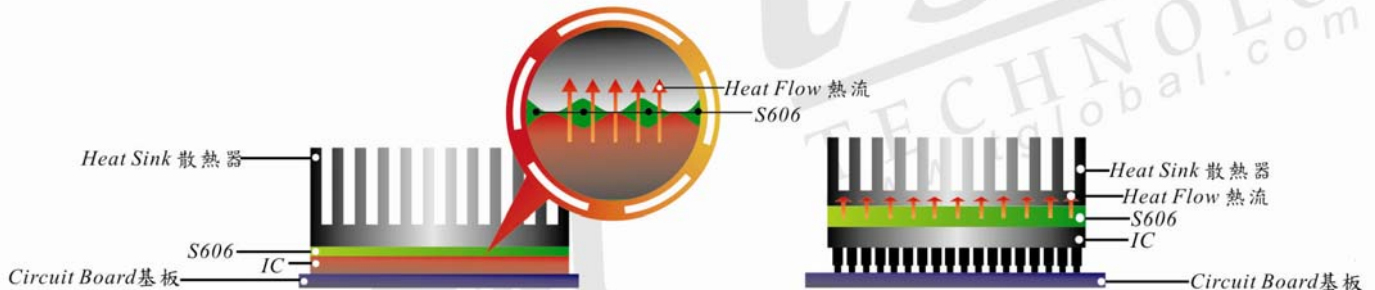


Storage

S606 has a self-life of eighteen (18) months from the date of manufacture, as indicated by the lot number, when stored in the original, unopened contained at, or below 25 °C.

保存方式

S606在未開封狀態，在室溫25°C以下可以保存18個月。



Property	S606	S606B	S606C	Unit	Test
Color 顏色	White 白色	White 白色	Gray 灰色	-	Visual
Thermal Conductivity 導熱係數	3.6	1.8	5	W/m.k	ASTM D5470
Weight Loss 重量損失	<0.5	<0.5	<0.5	%	ASTM E595
Specific gravity 比重	2.3	2.3	2.3	g/cm ³	ASTM D792
Volume Resistance 體積阻抗	1x10 ¹²	1x10 ¹²	1x10 ¹²	ohm-cm	ASTM D257
Working temperature 工作溫度	-40~+180	-40~+180	-40~+180	°C	-
REACH Compliant 符合REACH 規範	Yes 是		RoHS Compliant 符合RoHS 規範		Yes 是

- Need sample? 樣品需求

S606 - 30 gram

- Choose the P/N.
- Fill the quantity you need.

t-global 高柏科技有限公司 T-GLOBAL TECHNOLOGY CO., LTD

TECHNOLOGY
www.tglobal.com.tw

www.tglobal.com.tw service@tglobal.com.tw

Service Center: 0800211298 TEL: +886-2-26702575 FAX: +886-2-86776762

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